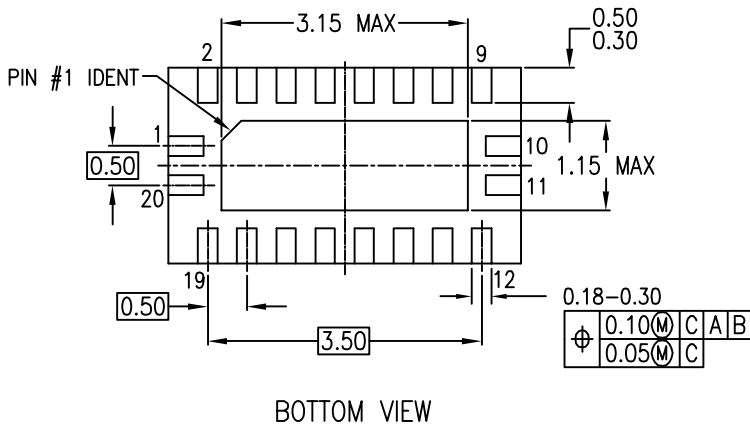
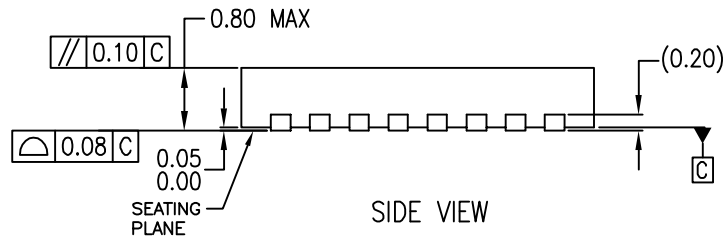
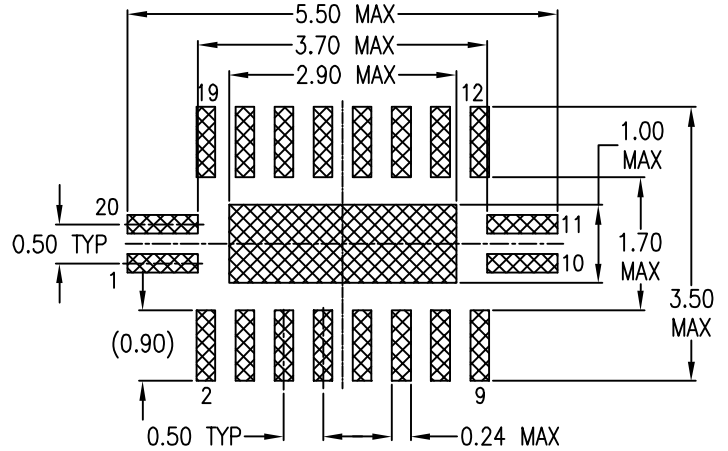
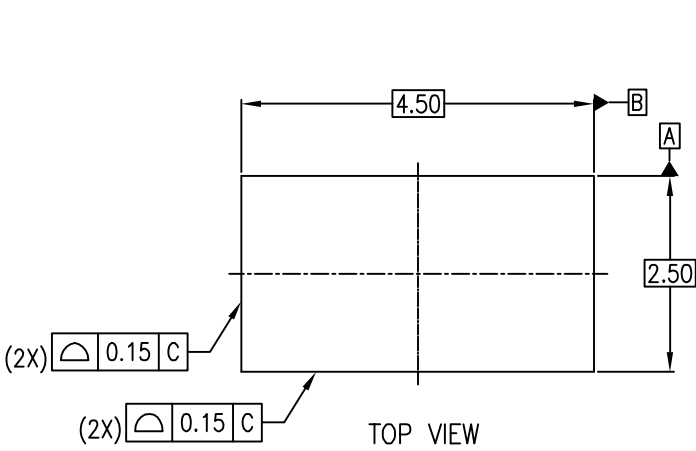


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REVISIONS				
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A	RELEASE TO DOCUMENT CONTROL		31-3-2003	FEITAN



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AC
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

MLP20BrevA

APPROVALS	DATE	FAIRCHILD Bayan Lepas, FIZ, SEMICONDUCTOR 11900, Penang, Malaysia.			
DRAWN FEITAN	17-3-2003	20LD, DQFN, JEDEC MO-241, 2.5x4.5 MM PACKAGE			
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		SCALE N/A	SIZE N/A	DRAWING NUMBER MKT-MLP20B	REV A
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